Series 136C





CENTIGRID® ESTABLISHED RELIABILITY MILITARY DPDT SENSITIVE CMOS COMPATIBLE

SERIES	RELAY TYPE
136C	DPDT sensitive relay with internal power MOSFET driver, Zener diode gate protection, and diode coil suppression

DESCRIPTION

The sensitive 136C Centigrid® relay is an ultraminiature, hermetically sealed, armature relay capable of being directly driven by most IC logic families. Its .100" grid spaced terminals, which preclude the need for spreader pads, make it ideal for applications where extreme packaging density and/or close PC board spacing are required.

The basic concept and internal mechanical structure are similar to the 134 DPDT relay. The following unique construction features and manufacturing techniques provide overall high reliability and excellent resistance to environmental extremes:

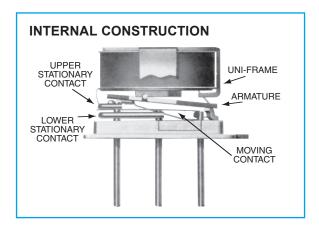
The 136C feature:

- All welded construction.
- Advanced cleaning techniques provide maximum assurance of internal cleanliness.
- Unique uni-frame design providing high magnetic efficiency and mechanical rigidity.
- · High force/mass ratios for resistance to shock and vibration.
- Precious metal alloy contact material with gold plating assures excellent
- high current and dry circuit switching capabilities.
- Low operating power

By virtue of its inherently low intercontact capacitance and contact circuit losses, the 136C relay has proven to be an excellent ultraminiature RF switch for frequency ranges well into the UHF spectrum. A typical RF application for this Centigrid® relay is in handheld radio transceivers, wherein the combined features of good RF performance, small size, low coil power dissipation and high reliability make it a preferred method of Transmit-Receive switching.

The Series 136C utilizes an internal silicon diode for coil suppression, a Zener diode to protect the MOSFET gate input, and an N-channel enhancement mode MOSFET chip, which enables direct relay interfacing with most Microprocessor and IC logic families (CMOS, TTL and MOS).

ENVIRONMENTAL AND PHYSICAL SPECIFICATIONS				
Temperature (Ambient)	–65°C to +125°C			
Vibration (Note 1)	30 g's to 3000 Hz			
Shock (Note 1)	75 g's, 6ms half sine			
Acceleration	50 g's			
Enclosure	Hermetically sealed			
Weight	0.18 oz. (5.11g) max.			
Reflow Temperature	260°C max. temp. 1 min. max			



Series 136C



CMOS DPDT Non-Latching Established Reliability / Military Relay

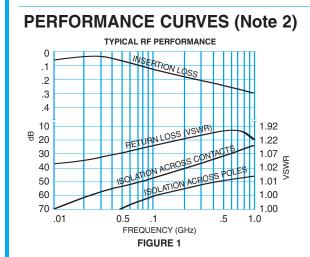
Everywhere	you	look			
		Part Nu	mbering System (5 &6)		
		T²R Es	stablished Reliability Relays		
Established Reliabili		gnator	U M4 - 26 A / S Q Q = Solder-Coated Leads (Sn60/Pb40) R = RoHS Compliant Solder (Sn99.7/Cu0.7)		
		Series	No Suffix = Gold-plated Leads		
(See	Apper Pad	option Option ndix A)	S = 0.187" Leads No Suffix = 0.75" Leads		
Nominal Co		,	Screening and Reliability Level		
(12 =	: 5V) : 12V) 26.5 V)	Міція	(A or B)		
(20	20.5 V)		ary Qualified (JAN) Relays CUM4 - 26 PL/Q		
		gnator	Q = Solder-Coated Leads (Sn60/ Pb40) No Suffix = Gold-Plated Leads		
		Option	Screening and Reliability Level (L or M)		
(See		ndix A) Option	P = 0.187" Leads No Suffix = 0.75" Leads		
(See		ndix A)	Nominal Coil Voltage (26 = 26.5 V, 12 = 12V, 5 = 5V)		
GENERAL ELECTI	RIC	AL SPECIFICATIO	NS (-65 °C to 125 °C unless otherwise noted. See notes 2 & 3.)		
Contact Arrangeme	ent		2 Form C (DPDT)		
Rated Duty			Continuous		
Contact Resistance	•		0.1 ohm max. before life; 0.2 ohm max. after life at 1A/28Vdc		
Contact Load Rating (DC)			Resistive: 1 A/ 28 Vdc Inductive: 200 mA/ 28 Vdc (320mH) Lamp: 100 mA / 28 Vdc (320mH) Low level: 10 to 50 μA @ 10 to 50 mV		
Contact Load Rating (AC)			Resistive: 250 mA / 115Vac, 60 and 400 Hz (Case not grounded) 100 mA / 115 Vac, 60 and 400 Hz (Case grounded)		
Contact Life Ratings			10,000,000 cycles (typical) at low level 1,000,000 cycles (typical) at 0.5 A / 28 Vdc resistive 100,000 cycles min. at all other loads specified above		
Contact Overload R	latir	ıg	2 A / 28 Vdc Resistive (100 cycles min.)		
Contact Carry Ratin	ng		Contact Factory		
Operate Time			4.0 ms max. at nominal rated coil voltage		
Release Time			7.5 ms max.		
Contact Bounce			1.5 ms max.		
Intercontact Capacitance			0.4 pf typical		
Insulation Resistance			10,000 M Ω min. between mutually isolated terminals		
Dielectric Strength	(V _{rm}	_{is} /60 Hz)	Atmospheric pressure: 500 70,000 ft: 125		
Negative Coil Transient			1.0 Vdc Max.		
Diode P.I.V.			100 Vdc Min.		
Zener Voltage		Min.	17 V _{dc}		
Lener Voltage		Max.	23 V _{dc}		
Zener Leakage Current (μA at 15.2 V _{dc}) (max.)			2.5 μΑ		
Power FET	Tu	rn Off Gate Voltage	0.5		
Characteristics (-65°C to +125°C) (V _{dc} , Max.)	Tu	rn On Gate Voltage	3.8 (Note 4)		
	Dra	ain-Source Voltage	55		

SPECIFICATIONS ARE SUBJECT TO CHANGE WITHOUT NOTICE © 2021 TELEDYNE RELAYS

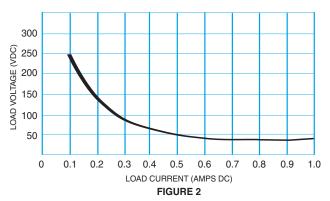


Series 136C CMOS DPDT Non-Latching Established Reliability / Military Relay

DETAILED ELECTRICAL SPECIFICATIONS (-65 °C to 125 °C unless otherwise noted. See note 3.)								
BASE PART NUMBERS (136C)	j	136C-5	136C-12	136C-26				
	Nom.	5.0	12.0	26.5				
Coil Voltage (V _{dc})	Max.	5.6	16.0	32.0				
Coil Curent	Max.	56.0	17.7	10.2				
(mA _{dc} @25°C)	Min.	43.0	11.3	5.8				
Coil Operating Power (mW, nominal)	250	180	219				
Pick-up Voltage (V _{dc} , Max) (Note 4)		4.0	9.8	19.5				
Gate Pick-up Voltage	Min.	0.13	0.36	0.72				
(V _{dc}) (Note 4)	Max.	2.3	6.5	13.0				



TYPICAL DC CONTACT RATING (RESISTIVE)

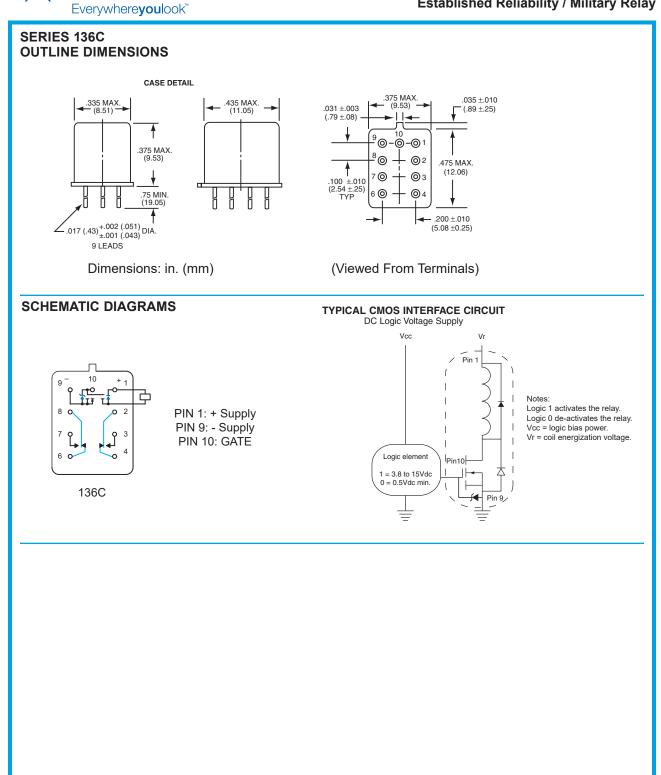


NOTES:

- 1. Relay contacts will exhibit no chatter in excess of 10 µs or transfer in excess of 1 µs.
- 2. "Typical" characteristics are based on available data and are best estimates. No on-going verification tests are performed.
- 3. Unless otherwise specified, parameters are initial values.
- 4. Maximum rated gate voltage = 15 V_{dc} .
- 5. Unless otherwise specified, relays will be supplied with Gold-plated Leads.
- 6. The slash and character appearing after the slash are not marked on the relay.

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CMOS DPDT Non-Latching Established Reliability / Military Relay



TELEDYNE

RELAYS



Series 136C CMOS DPDT Non-Latching Established Reliability / Military Relay

Everywhere you look [™]	Established Reliability / Military Relay							
	APPENDIX A : Sp	oacer Pads						
Pad designation and bottom view dimen- sions	Height	For use with the follow- ing:	Dim. H Max.					
.156 [3.96] (REF)		122C, A152	.320 (8.13)					
		ER116C, J116C	.300 (7.62)					
 [6.5] (REF) 0 0 0 (REF) 0 0		ER136C, J136C	.400 (10.16)					
		RF180	.325 (8.25)					
"M9"Spacer Pad for Centigrid [®]		A150	.305 (7.75)					
 To specify a "M9" spacer pad, refer to the mounting variants portion of the part numbering example in the applicable datasheet. Dimensions are in inches (mm). Unless otherwise specified, tolerance is ± .010" (.25 mm). Add 10 mΩ to the contact resistance shown in the datasheet. Add 0.01 oz. (0.25 g) to the weight of the relay assembly shown in the datasheet. 								
APPENDIX A: Ground Pin Positions								
Centigrid® Relays: RF180, ER116C, 122C, ER136C								
 Indicates ground pin position Indicates glass insulated Indicates ground pin or led depending on relay type 	lead position2. Dimensionad position3. Tolerancead position4. Ground pi5. Ground pi	views shown ns are in inches (mm) s: ± .010 (±.25) unless otherwise spec n positions are within .015 (0.38) dia. n head dia., 0.035 (0.89) ref: height 0. 0.017 (0.43) nom.	of true position					